R6014YNX3

Nch 600V 215mohm(typ.) Power MOSFET

Datasheet

V _{DSS} (@Tj max.)*5	650V
$R_{DS(on)}(Max.)$	260mΩ
I _{DP} *2	±42A
P _D	132W

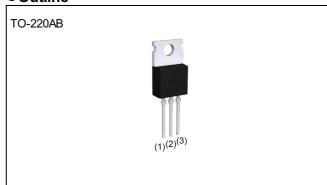
Features

- 1) Low on-resistance
- 2) Fast switching
- 3) Parallel use is easy
- 4) Pb-free lead plating; RoHS compliant
- 5) Halogen free mold compound

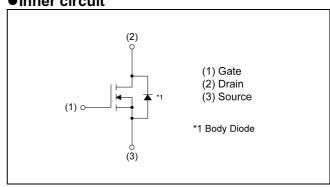
Application

Switching applications

Outline



•Inner circuit



Marking	R6014YNX3
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● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V_{DSS}	600	V
Continuous drain current (T _c = 25°C)	I _D *1	±14	Α
Pulsed drain current	I _{DP} *2	±42	А
Gate - Source voltage	V _{GSS}	±30	V
Avalanche current, single pulse	I _{AS}	1.0	А
Avalanche energy, single pulse	E _{AS} *3	59	mJ
MOSFET dv/dt	dv/dt*4	120	V/ns
Power dissipation (T _c = 25°C)	P _D	132	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Davamatav	O	Values			1.1-24
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	0.95	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	62.5	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

● Electrical characteristics (T_a = 25°C)

Darameter	Cumb al	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	600	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V	-	-	100	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30 V, V_{DS} = 0 V$	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 1.4$ mA	4	5	6	V
Static drain - source	D *5	V _{GS} = 12V, I _D = 5A	-	215	260	mΩ
on - state resistance	R _{DS(on)} *5	V _{GS} = 10V, I _D = 5A	-	237	285	mΩ
Gate resistance	R_{G}	f = 1MHz, open drain	-	1.6	-	Ω

● Electrical characteristics (T_a = 25°C)

Davanatas	Cy made al	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 100V	-	890	-	
Output capacitance	C _{oss}	f = 100kHz	-	35	-	
Effective output capacitance energy related	C _{o(er)} *6	V _{GS} = 0V	-	35	-	pF
Effective output capacitance time related	C _{o(tr)} *7	V _{DS} = 0V to 480V	-	200	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300V$, $V_{GS} = 12V$	-	22	-	
Rise time	t _r *5	I _D = 5A	-	15	-	
Turn - off delay time	t _{d(off)} *5	R _L ~ 60Ω	-	42	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	13	-	

• Gate charge characteristics ($T_a = 25$ °C)

Darameter	Cumb al	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≈ 300V	-	20	1	
Gate - Source charge	Q _{gs} *5	I _D = 5A	-	6.5	1	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	10	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300V$, $I_D = 5A$	-	7.5	-	V

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Davamatav	Currely of	Constitution of	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Source current	I _S *1	T = 25°C	-	-	9	А
Pulsed source current	l _{SP} *2	T _C = 25°C	-	-	42	Α
Source-Drain voltage	V _{SD} *5	$V_{GS} = 0V$, $I_S = 5A$	-	-	1.5	V
Reverse recovery time	t _{rr} *5	V _{DD} ≃ 400V	-	250	-	ns
Reverse recovery charge	Q _{rr} *5	I _S = 5A	-	2.3	-	μC
Peak reverse recovery current	_m *5	di/dt = 100A/μs	-	19	-	Α

^{*1} Limited only by maximum channel temperature allowed.

^{*2} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*3} L \rightleftharpoons 100mH, V_{DD}=50V, R_G=25 Ω , starting T_i=25 $^{\circ}$ C

^{*4} $V_{DS} = 0$ to 400V

^{*5} Pulsed

 $^{^{*}}$ 6 Co(er) is a fixed capacitance that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .

^{*7} Co(tr) is a fixed capacitance that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .

Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

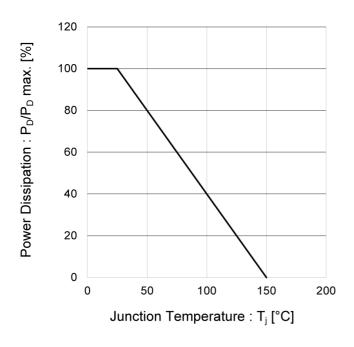


Fig.2 Drain Current Derating
Curve vs. Junction Temperature

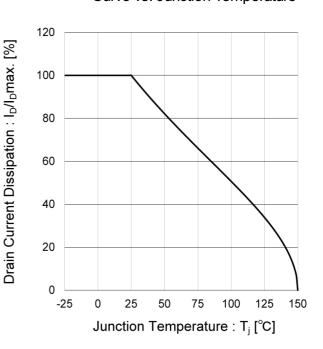


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

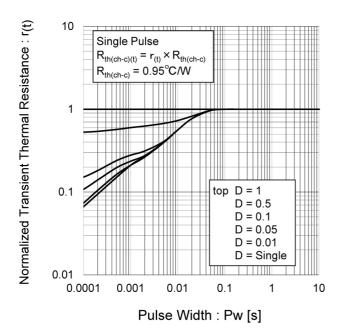
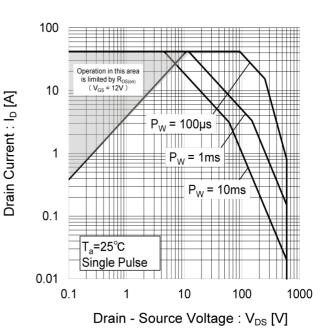


Fig.4 Maximum Safe Operating Area



• Electrical characteristic curves

Fig.5 Avalanche Energy Derating
Curve vs. Junction Temperature

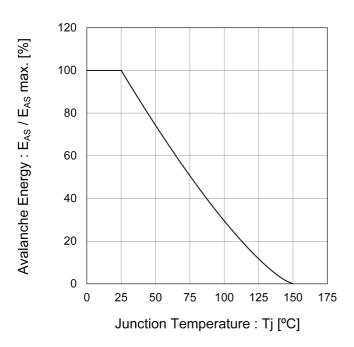


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

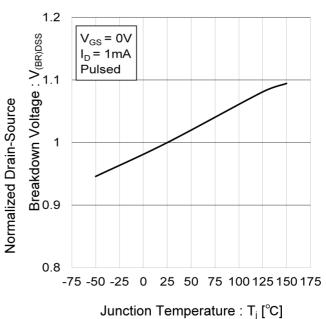


Fig.7 Typical Output Characteristics(I)

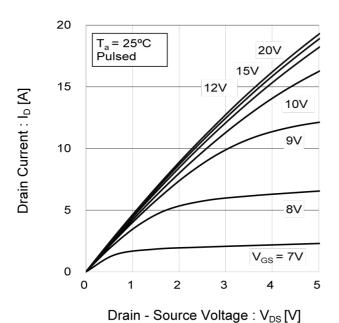
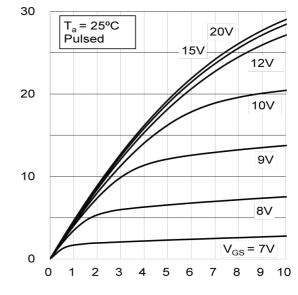


Fig.8 Typical Output Characteristics(II)



Drain - Source Voltage: V_{DS}[V]

Drain Current : I_D [A]

Electrical characteristic curves

Fig.9 Typical Transfer Characteristics

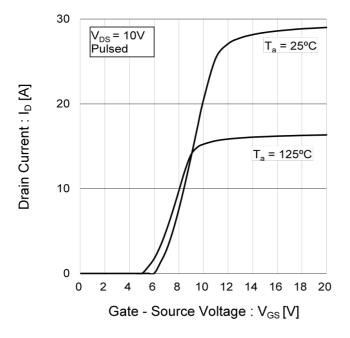


Fig.10 Normalized Gate Threshold Voltage vs. Junction Temperature

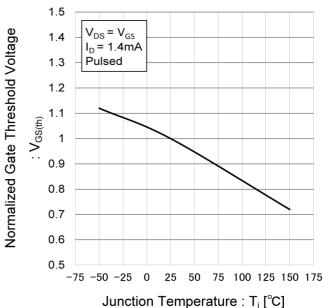


Fig.11 Static Drain - Source On - State Resistance vs. Gate Source Voltage

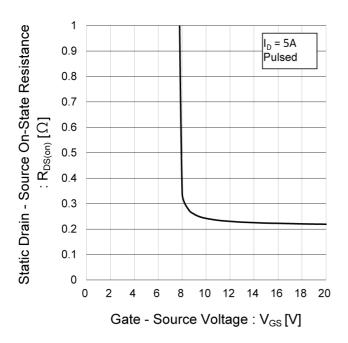
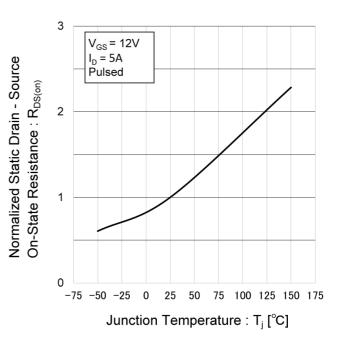


Fig.12 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature



Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Drain Current

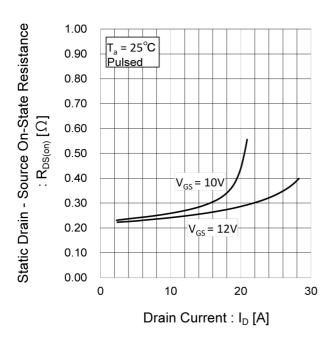


Fig.14 Capacitances

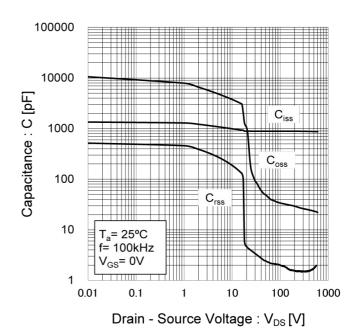


Fig.15 Coss Stored Energy

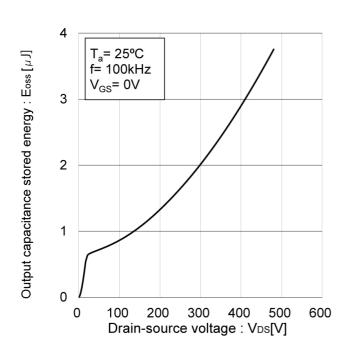
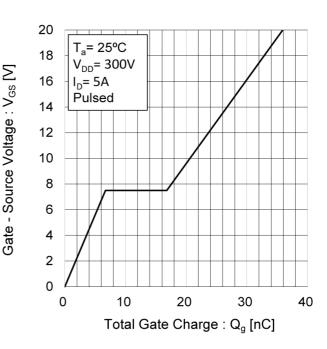
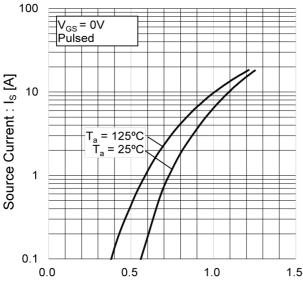


Fig.16 Gate charge



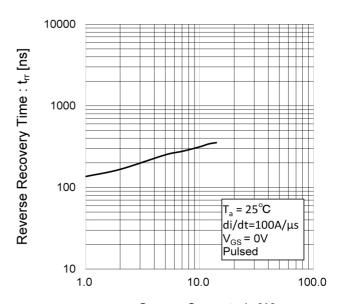
• Electrical characteristic curves

Fig.17 Source Current vs. Source - Drain Voltage



Source - Drain Voltage : V_{SD} [V]

Fig.18 Reverse Recovery Time vs. Source Current



Source Current : I_S [A]

Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

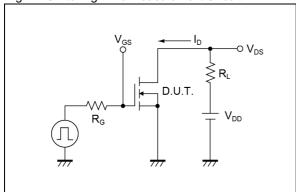


Fig.2-1 Gate Charge Measurement Circuit

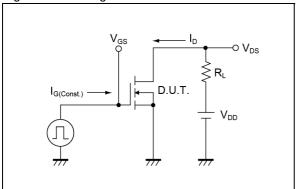


Fig.3-1 Avalanche Measurement Circuit

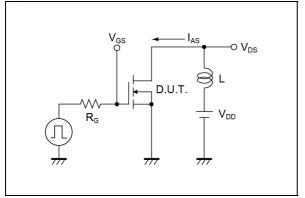


Fig.4-1 Diode Recovery Measurement Circuit

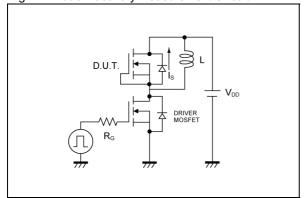


Fig.1-2 Switching Waveforms

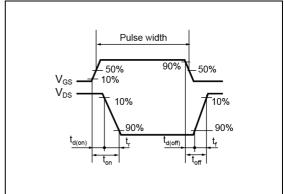


Fig.2-2 Gate Charge Waveform

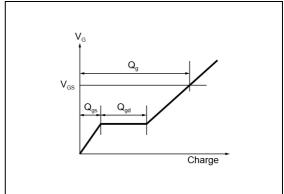


Fig.3-2 Avalanche Waveform

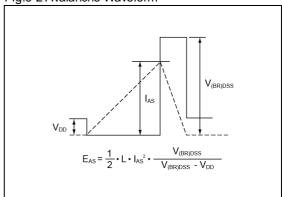
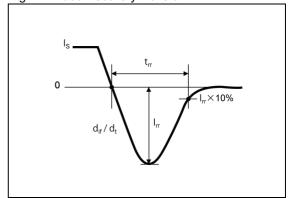
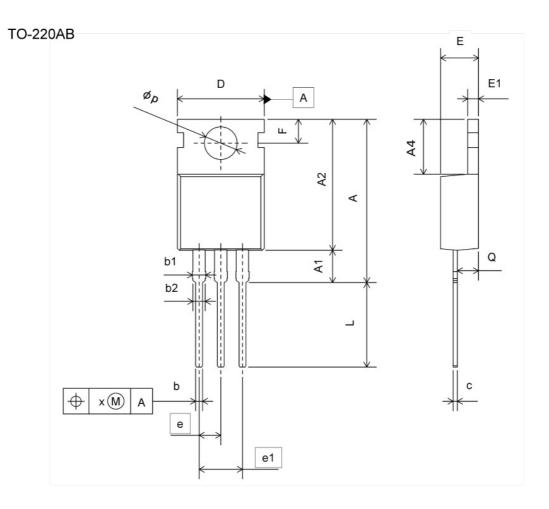


Fig.4-2 Diode Recovery Waveform



Dimensions



DIM	MILIME	TERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	18.30	20.00	0.720	0.787
A1	3.60	4.00	0.142	0.157
A2	14.70	16.00	0.579	0.630
A4	6.30	6.60	0.248	0.260
b	0.65	0.95	0.026	0.037
b1	1.20	1.75	0.047	0.069
b2	1.20	1.70	0.047	0.067
С	0.35	0.65	0.014	0.026
D	9.96	10.36	0.392	0.408
E	4.24	4.64	0.167	0.183
E1	1.14	1.40	0.045	0.055
е	2.	54	0.1	00
e1	5.	08	0.2	200
F	2.60	3.00	0.102	0.118
L	9.47	10.37	0.373	0.408
ϕ p	3.69	3.99	0.145	0.157
Q	2.30	2.70	0.091	0.106
Х	-0	0.38	-	0.015

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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